

#### Pamphlet

# High performance chip resistor

- High precision chip resistors
- High temperature chip resistors
- Anti-sulfurated chip resistors
- Current sensing chip resistors
- Small & High power chip resistors
- High voltage & High accuracy chip resistors











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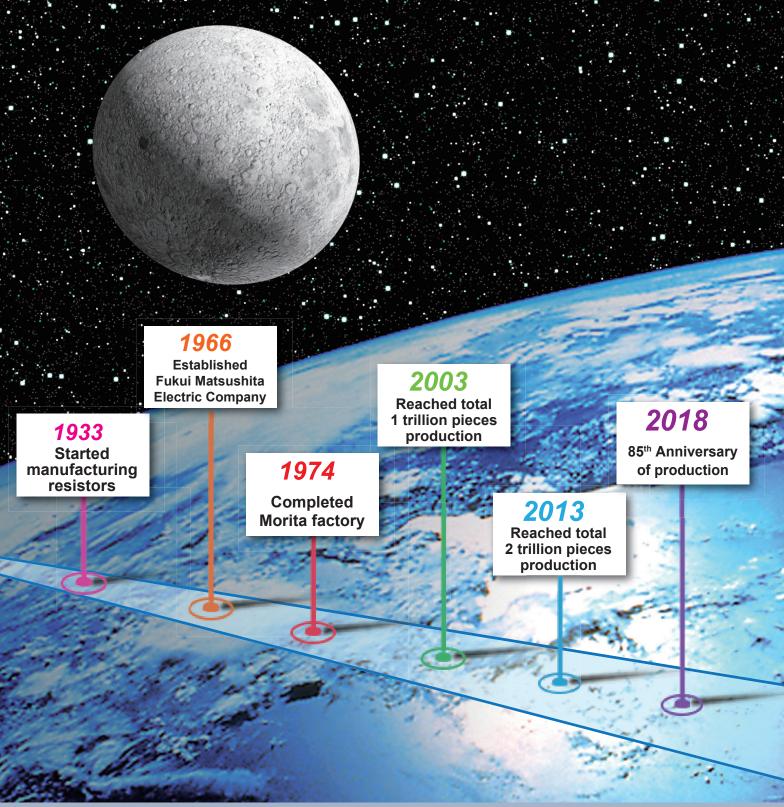
Panasonic Industry will assume no liability whatsoever if the use of our company's products deviates from the contents of this catalog or does not comply with the precautions. Please be advised of these restrictions.

# 91 years history of our company resistors

Our company has produced resistors for more than 91 years.

Based on the concept, "Good products begin with Good components." by our founder Konosuke Matsushita, Panasonic started manufacturing fixed

- carbon film resistors for radio receivers in 1933 and reached the milestone ... of accumulative 2 trillion pieces production by 2013.
- By lining up with this number of resistors, standard 1608 mm size, we can make a round trip to the moon (244,198 miles).



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	High temperature typ	е	ERJH series	P14				
Environment resistant	Anti-sulfurated type	Normal High precision Small & high powe Low resistance Array Wide terminal	: ERJS/U series : ERJU*R series r : ERJC/ERJUP series : ERJU*S/Q series : EXBU series : ERJC series	P15				
	Anti-sulfurated series	Anti-sulfurated series line-up						
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Down sizing proposal								
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#### [Description of the icon]

Down sizing

: Reducing size what same power rating

Anti-Surge High precision

: Improving durability for overloading

: Significantly reducing total resistance tolerance

Anti solder joint crack : Reducing anti solder joint crack in heat cycle environment

High power

: Reaching higher power rating with same size

CR

: Reducing variation of resistance value under temperature variation

Anti-Sulfurated

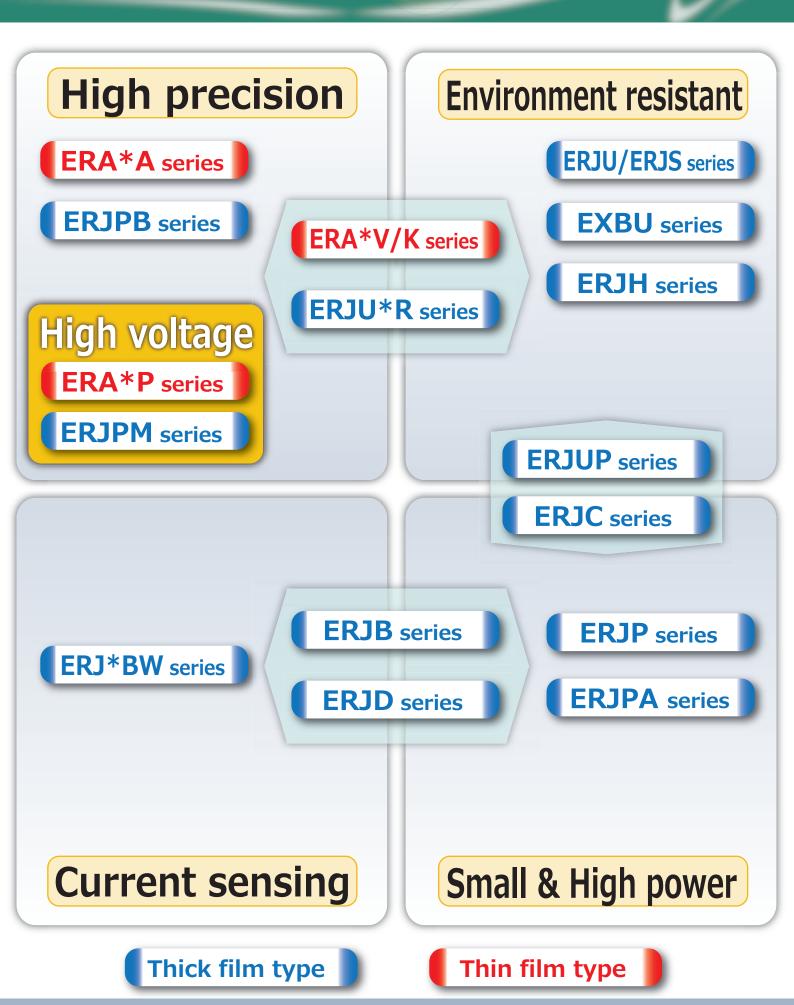
: Reducing variation of resistance value under sulfur environment

: Reducing variation of resistance value under high temperature environment

: Conforming AEC-Q200



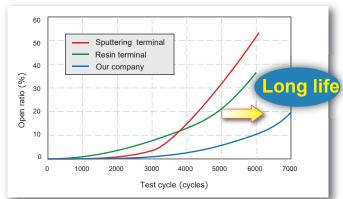
# Our company chip resistors, product line-up



# Characteristics of our company thick film chip resistors

# Anti solder joint crack

Reduces solder joint crack progression by originally developed soft terminal



	Our company	Other company				
	Resin terminal (Soft terminal)	Resin terminal	Sputtering terminal			
3000 cycle						
	No solder crack	Solder	crack			

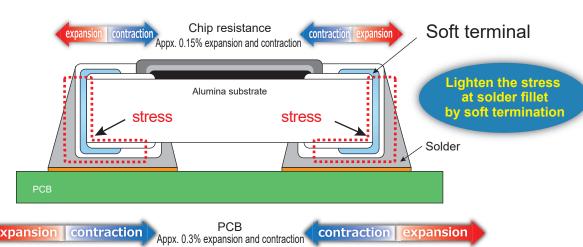
# Reduce solder joint crack

- 1. Long life for the set of device
- 2. Improvement of reliability



#### Soft termination technology adopted

◆ Cooling and heating cycle lightens the stress ◆



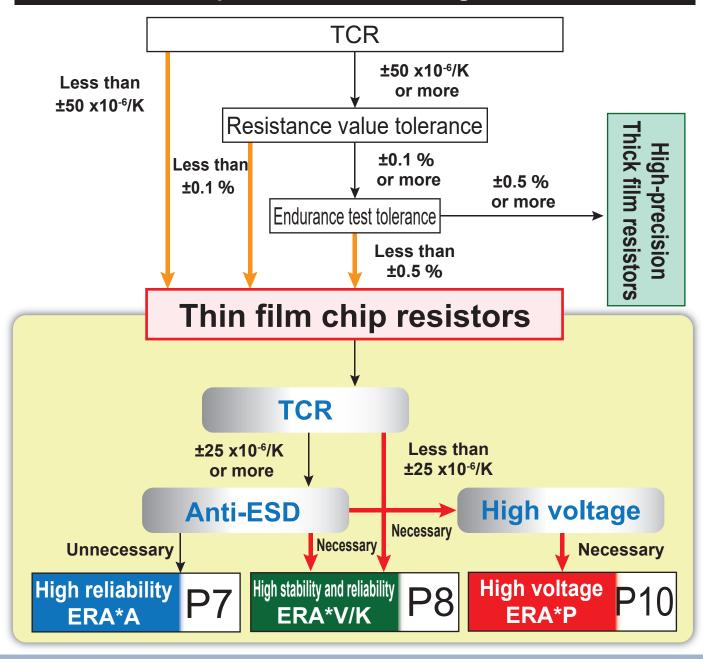
Maintain exellent solder connection reliability even in harsh temperature environment such as for automotive.

# Proper Usage: Thick film & Thin film chip resistors

#### **Tolerance · TCR Matrix** TCR (x10-6/K) 10 15 25 50 100 100 < Tolerance (%) Thick film chip area 0.05 ERA\*P 0.1 ERA\*V/K ERA\*A 0.5 Thin film chip area 1 5

\*Our recommended combinations for Tolerance & TCR

#### Chip resistors selection guide



# High precision Thin film, High reliability type

High precision Low TCR Anti solder joint crack

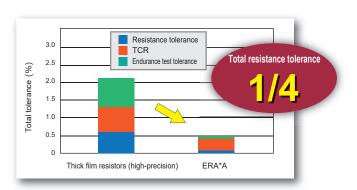
AEC-Q200

## **ERA\*A** series



Reduce total resistance value by 1/4 from high-precision thick film resistors

- ∨ Resistance tolerance ± 0.1 %
- √ TCR ± 25 x10<sup>-6</sup>/K
- Endurance test tolerance ± 0.1 %

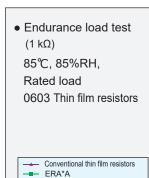


## Quarter total tolerance from high-precision thick film resistors

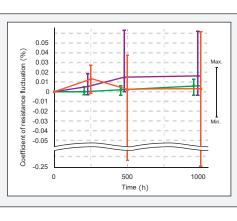
- 1. Suppress deterioration of set's performance and reliability in long-term use and temperature change
- 2. Save design cost by design margin securing

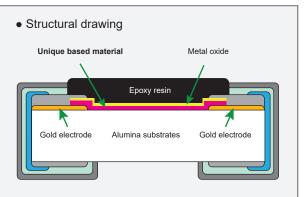


# Achieving high-stability (Endurance test tolerance less than 0.1%) with the unique based material



High-precision thick film resistors





#### ■ Specifications

Part No.	Size (inch)	Power rating (W)	Limiting element voltage (V)	Resistance tolerance (%)	Resistance range (Ω)	TCR (x10 <sup>-6</sup> /K)	Category temp. range (℃)
ERA1AEB	0201	0.05	25	± 0.1	100 to 10 k	± 25	
ERA2AEB	0402	0.063	50	± 0.1	47 to 100 k	± 25	
ERA3AEB	0603	0.1	75	± 0.1	47 to 330 k	± 25	-55 to +155
ERA6AEB	0805	0.125	100	± 0.1	47 to 1 M	± 25	
ERA8AEB	1206	0.25	150	± 0.1	47 to 1 M	± 25	



# **High precision** Thin film, High stability and reliability type

High precision **TCR** 

Anti solder joint crack

Surge

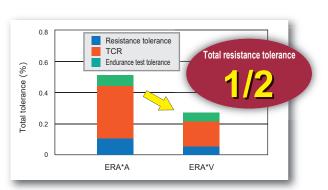
**Q200** 

# ERA\*V/K series

\*1·ERA\*A

Achieving higher-precision and longer-life than conventional\*1 series

- Resistance tolerance ± 0.05 %
- $TCR \pm 10 \times 10^{-6} / K$
- Endurance test tolerance ± 0.1 %



## Half total tolerance from thin film chip resistors (Conventional series)

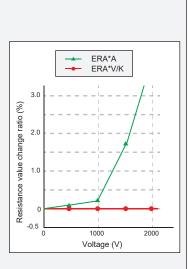
- 1. High-precision, design margin securing and improve performance
- 2. Improve reliability in severe conditions

**Point** 

Highest level of ESD resistance by preventing current concentration and reducing electric field strength

#### Anti-ESD

 ESD test (1 kΩ) HBM: 150 pF,2 kV,±5 times 0603 Thin film chip resistors



 Anti-ESD improved design Resistor film thickness regularization New V/K series Conventional\*1 A series In alumina grain boundaries In alumina grain boundaries **Current intense** (small grain size (large grain size) prevention thin resistor film area Regularize resistor film by Resistor film smoothing surface of alumina substrates and prevent currenct Alumina substrate Intensity of overcurrent locally  $\rightarrow$  **Destory resistor** No intensity of overcurrent → No destory resistor Expand resistor pattern length

Conventional\*1 A series

Electric field strength reduction Reduce electric potential

difference on length wise by expandin resistor



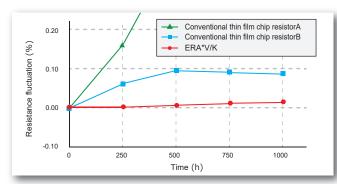


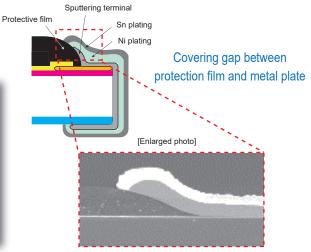
# Improve anti-sulfurated by the introduction of edge sputtering electrode covering gap between protection film and electrode

#### **Anti-sulfurated**

Sulfurization gas test

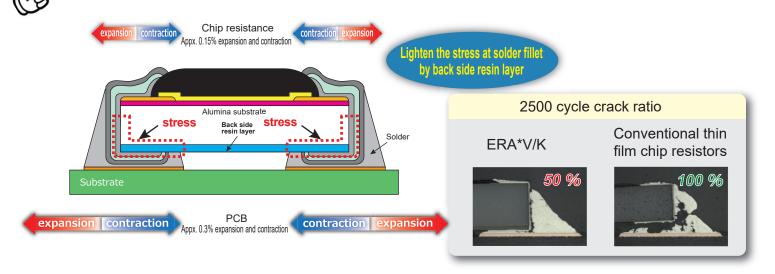
ASTM B809 : 105 °C 0603 Thin film chip resistors





Point

#### Achieve excellent anti solder joint crack by back side resin layer



#### Specifications

■ Specifica	1110113							
Part No.	Size (inch)	Power rating (W)	Limiting element voltage (V)	Resistance tolerance (%)	Resistance range $(\Omega)$	TCR (x10-6/ K)	ESD withstand voltage (kV)	Category temp. range (℃)
ERA2V	0402	0.100	75	± 0.1 ±0.05	$1 \text{ k} \le R \le 47 \text{ k}^{*1}$ $47 \le R \le 100 \text{ k}^{*1}$	±10(R) ±15(P) ±25(E)	1.0	
ERA3V ERA3K (100 kΩ over)	0603	0.125	100	± 0.1 ±0.05	1 k ≤ R ≤ 100 k 47 ≤ R ≤ 240 k	±10(R) ±15(P) ±25(E)	1.5	-55 to +155
ERA6V ERA6K (100 kΩ over)	0805	0.250	150	± 0.1 ±0.05	1 k ≤ R ≤ 100 k 47 ≤ R ≤ 750 k	±10(R) ±15(P) ±25(E)	2.0	-55 to +155
ERA8V ERA8K (100 kΩ over)	1206	0.250	200	± 0.1 ±0.05	1 k to 160 k 1 k to 1 M 47 to 1 M	±10(R) ±15(P) ±25(E)	2.0	

\*1: Expansion of resistance range



Anti solder joint crack

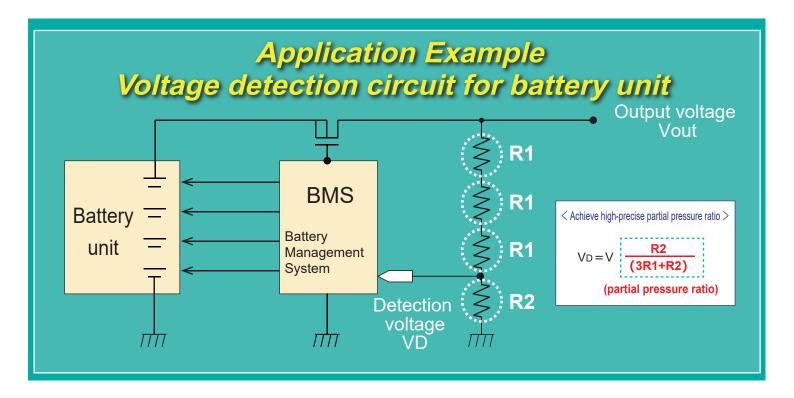
**Q200** 

# ERA8P (Thin film) series ERJPM8 (Thick film) series



Reconciling the high limiting element voltage and the high precision.

- Limiting element voltage 500 V
- Resistance value accuracy Max. ± 0.1 %, ±15 x10<sup>-6</sup>/K
- ∨ Anti-solder crack design



#### Specifications

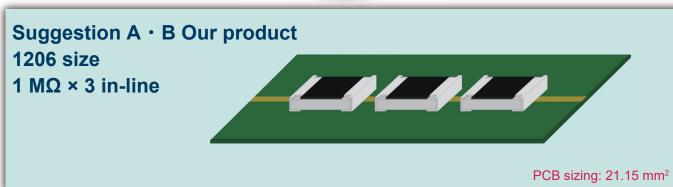
Part No.	Size (inch)	Power rating (W)	Limiting element voltage (V)	Resistance tolerance (%)	Resistance range (Ω)	TCR (x10 <sup>-6</sup> /K)	Category temp. range (℃)
ERA8PPB		0.25		. 0.4		± 15	
ERA8PEB	1206	(@85 ℃)	500	± 0.1	(E24, E96)	± 25	-55 to +155
ERJPM8F		0.66 (@70 ℃)		± 1	1.02 M to 10 M (E24, E96)	± 100	



# — Proposal for the voltage sensing applications. —

Current Other companies' products 0805 size 300 k $\Omega$  × 10 in-line PCB sizing: 40.25 mm<sup>2</sup>





	Resistance value x usage	Resistance tolerance (%)	TCR (x10 <sup>-6</sup> /K)	Working voltage (V)	PCB sizing* (mm²)
Current : Other company 2012 Thin film resistance	300 kΩ x 10 in-line	± 0.1	+ 25	150 x 10 p = 1500	40.25
Suggestion A : ERA8PEB 1206 Thin film high resistance	1 ΜΩ	± 0.1	123	500 x 3 p	21.15
Suggestion B : ERJPM8F 1206 High resistance and high withstand voltage	x 3 in-line	±1	± 100	= 1500	(About 48% Reduction)

Our company unique computation.

# High precision High precision thick film type

High precision

Low TCR Anti solder joint crack

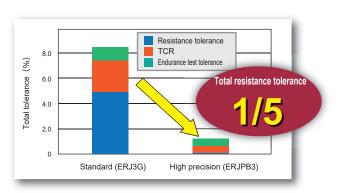
AEC-Q200

### **ERJPB** series



#### Same tolerance level as thin film

- ∨ Resistance tolerance ± 0.1 %
- √ TCR ± 50 x10<sup>-6</sup>/K
- ∨ Endurance test tolerance ± 0.5 %

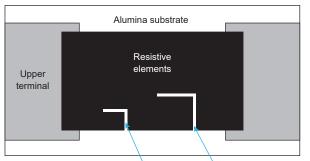


#### Cut the total tolerance to 1/5

- 1. Design margin securing
- 2. Improvement of reliability
- 3. Cost saving for IC by reducing correction circuit



Achieved high precision resistance tolerance: ±0.1% by unique resistive material and trimming



By unique "Double L-shaped trimming" process, we can make slight adjustments of resistance value.

(2nd small L-shaped trimming has low

adjustment rate)

Trimming groove 1

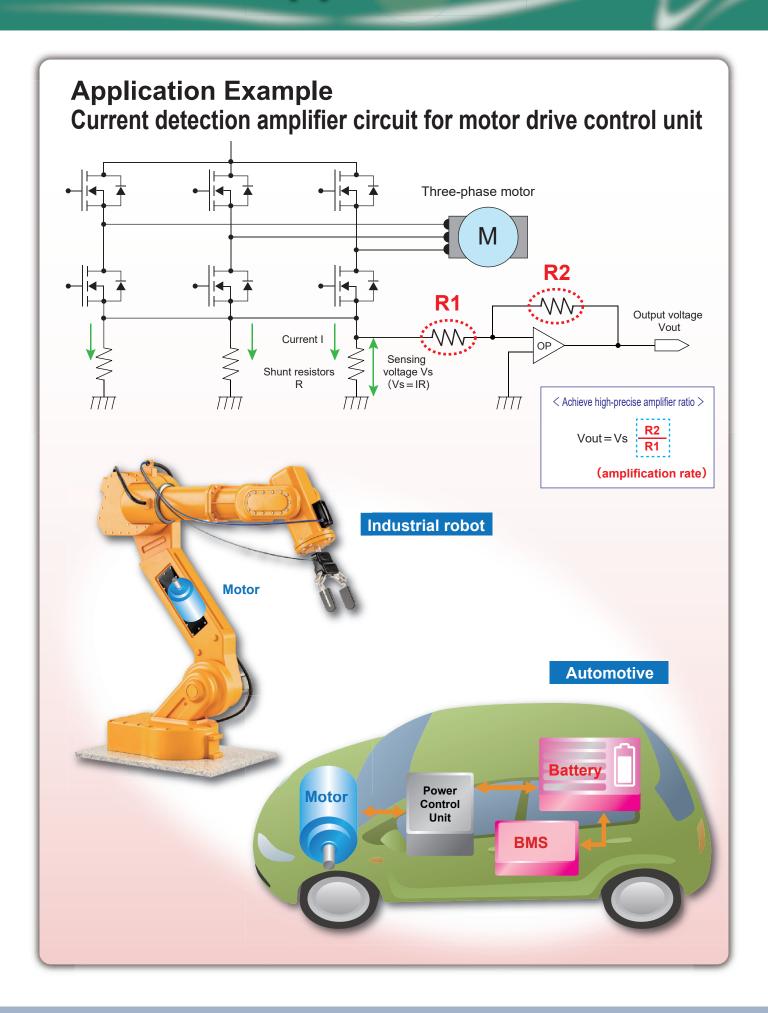
Trimming groove 2

#### ■ Specifications

Part No.	Size (inch)	Power rating (W)	Limiting element voltage (V)	Resistance tolerance (%)	Resistance range (Ω)	TCR (x10 <sup>-6</sup> /K)	Category temp. range (℃)
ERJPB3B	0603	0.20	150	± 0.1, ± 0.5	200 to 100 k	± 50	FF to 14FF
ERJPB6B	0805	0.25	150	± 0.1, ± 0.5	200 to 1M	± 50	-55 to +155



# **Application**



# **Environment resistant** High temperature chip resistor

power

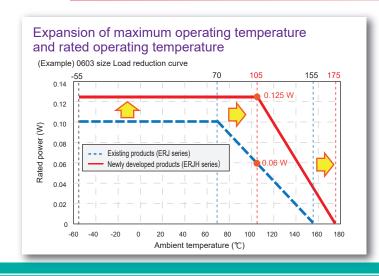
High temperature

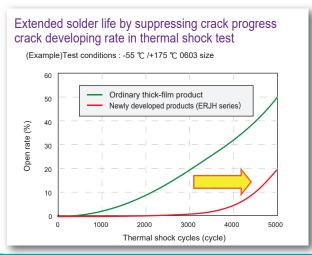
Q200

### **ERJH** series



#### Achieves high heat resistance by new materials developing





## Guarantees that the resistor endures 1000 cycles of thermal shock testing(-55 $^{\circ}$ C/+175 $^{\circ}$ C)

- 1. Expand of max operating temperature 155 ℃ =
- 2. Expand of rated operating temperature 70  $^{\circ}$ C  $\Rightarrow$
- 3. Improvement of solder crack resistance



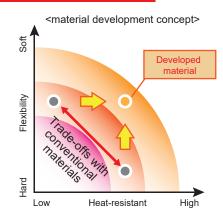
#### **Excellent high heat resistance due to both** material flexibility and heat resistance

Overcome the trade-offs of conventional materials by reviewing the design of raw materials

√ Improvement of operating temperature

Max operating temp. : 175 ℃ Rated operating temp.: 105 ℃ cracks

√ Suppression of solder



#### Specifications

Part No.	Size (inch)  Power rating (W)  Resistance tolerance (%)		Resistance range (Ω)	Category temp. range (℃)		
ERJH2	0402	0.10		1 to 300 k		
ERJH3G/E	0603	0.125	. 0 5 . 4 . 5	1 to 300 K	-55 to +175	
ERJH3Q	0003	0.25	± 0.5, ± 1, ±5	1 to 10	-55 10 +175	
ERJHP6	0805	0.50		1 to 300 k		



# **Environment resistant Anti-Sulfurated series**

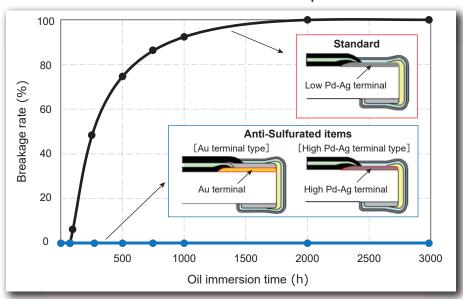
AEC-

: ERJS/U series Low resistance : ERJU\*S/Q series Standard Small size & High power: ERJC/ERJUP series **: EXBU** series Array \*1

High precision: ERJU\*R series Wide terminal

Anti-Sulfurated terminal reduces variation in the resistance value under harsh environment(sulfur)

Sulfurized oil immersion test of chip resistors



[Breakage in conventional items]

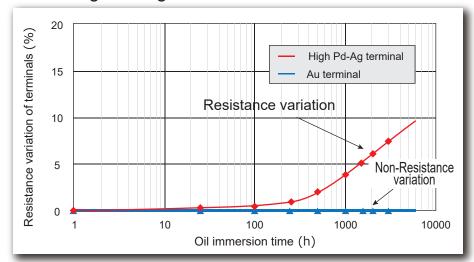


Sulfurated Ag needle crystal

[Non-Breakage in anti-sulfuraed items]



 Sulfurized oil immersion test of Au terminal and high Pd-Ag terminal



The sulfurization is inhibited with using Gold or Silver with high concentration Palladium as the inner electrode material. Each design have the high anti-sulfuration characteristics, but Gold type is much better.

### With Anti-Sulfurated characteristics,

- 1. High reliability by reducing sulfurated breakage
- 2. Improve reliability of device at harsh environment
- 3. Cost reduction by unnecessary of sealing substrate

## **Anti-Sulfurated series Line-up**

#### < Wide lineup of Anti-Sulfurated chip resistors with anti-sulfurated electrode >

Ту	Size (inch)	01005	0201	0402	0603	0805	1206	1210	2010 1020 (Wide terminal)	2512	Web catalog
04				ERJS02	ERJS03	ERJS06	ERJS08	ERJS14	ERJS1D	ERJS1T	Clink
Sta	ındard	ERJU0X	ERJU01	ERJU02	ERJU03	ERJU06	ERJU08	ERJU14	ERJU1D	ERJU1T	Click
Pre	ecision			ERJU2R	ERJU3R	ERJU6R					Click
	nall & h power				ERJUP3	ERJUP6	ERJUP8				Click
	Low istance					ERJU6S					Clink
	o to 1Ω)					ERJU6Q					Click
ninal	Low								ERJC1B		
Wide terminal	resistance (10 mΩ to 1Ω)								ERJC1C		Click
	2 resistors		EXBU14	EXBU24	EXBU34						
Array	4 resistors		EXBU18	EXBU28	EXBU38						Click
	8 resistors			EXBU2H							

# Current sensing Low TCR high power / wide terminal type

Low TCR Down sizing

High power

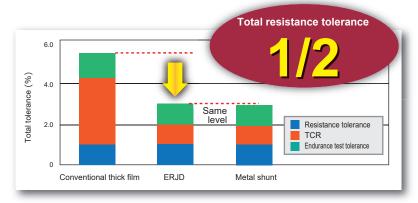
Anti solder joint crack

AEC-Q200

## **ERJD** series



Achieved low-resistance / low-TCR ~ VA proposal for metal shunt resistors ~



[ Reduces TCR of 10 m $\Omega$  from 350 x10-6/K to 100 x10-6/K ]

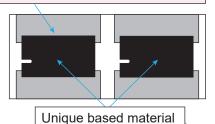
## Achieved same level performance as metal shunt resistor

- 1. Design margin securing
- 2. Improvement of reliability
- 3. Cost saving



#### Achieved low resistance TCR by unique resistive material

Reducing resistance value on the electrode



- •TCR is reduced with using Ag (Silver) / Pd (palladium) or Cu (Copper) / Ni (Nickel) as the resistive material.
- •Achieved low TCR as same level as metal shunt resistors at more than 10  $\Omega$ .

Resistive optimization material

#### Specifications

Part No.	Size (inch)	Power rating (W)	Resistance tolerance (%)	Resistance range (Ω)	TCR (ppm/K)	Category temp. range (℃)
ERJD1	1020	2.0	± 1, ± 5	10 m to 200 m	± 100	FE to 155
ERJD2	0612	1.0	± 1, ± 5	10 m to 200 m	± 100	-55 to 155



AEC-Q200

## **ERJ\*BW** series



Small case size, low resistance, and high power by double-sided resistive elements structure



[ Achieved smaller case size(1206  $\rightarrow$  0805) than conventional type for 10 m $\Omega$  ]

#### PCB area reduction

1. Down sizing 2. Weight saving 3. Cost saving



Realized small current sensing resistors by double-sided resistive elements structure

#### Double-sided resistive elements structure

Protective Resistive coating element Terminal

Alumina substrate



[ Top view ]

**Back side trimming** 

- Load concentration is reduced by two symmetrical L-shaped trimming,
- Achieved small size & high power and overload characteristics.

#### Specifications

- Opcom	Cations					
Part No.	Size (inch)	Power rating (W)	Resistance tolerance (%)	Resistance range (Ω)	TCR (x10 <sup>-6</sup> /K)	Category temp. range (℃)
ERJ2BW	0402	0.25	± 1, ± 2, ± 5	47 m to 100 m	0 to +300	
ERJ3BW	0603	0.33	± 1, ± 2, ± 5	20 m to 100 m	$\begin{array}{lll} 20m\Omega \leq R < 39m\Omega & : 0 \text{ to } +250 \\ 39m\Omega \leq R \leq 100m\Omega & : 0 \text{ to } +150 \end{array}$	
ERJ6BW	0805	0.5	± 1, ± 2, ± 5	10 m to 100 m	$\begin{array}{ll} 10m\Omega \leq R < 15m\Omega & : 0 \text{ to } +300 \\ 15m\Omega \leq R \leq 100m\Omega & : 0 \text{ to } +200 \end{array}$	-55 to +155
ERJ8BW	1206	1.0	± 1, ± 2, ± 5	10 m to 100 m	$\begin{array}{lll} 10m\Omega \leq R < 20m\Omega & : 0 \text{ to } +200 \\ 20m\Omega \leq R < 47m\Omega & : 0 \text{ to } +150 \\ 47m\Omega \leq R \leq 100m\Omega & : 0 \text{ to } +100 \end{array}$	



# Small size & High power Anti-Surge type

Down sizing

Anti solder joint crack

High

power

Surge AEC-Q200

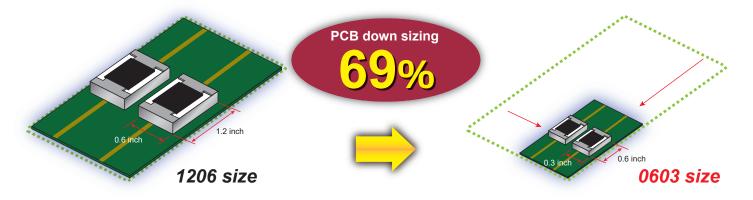
Anti-

Low TCR

## **ERJPA/P0** series



#### Improvement of High power & Anti-Surge rating



## PCB area reduction

- 1. Down sizing
- 2. Weight saving
- 3. Cost saving

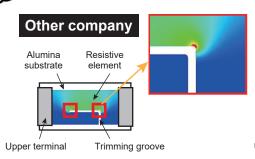
## **High Anti-Surge performance**

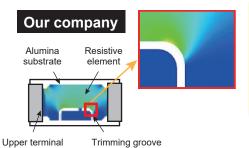
- 1. Failure reduction
- 2. Design margin securing





### Surge distribution by unique resistive material / trimming





- Unique "Double-C shaped trimming" for surge distribution.
- Achived small size & high power and overload characteristics.

#### Specifications

_ ' _ , , , , , , , , , , , , , , , ,										
Part No.	Size (inch)	Power rating*1 (W)		Limiting element voltage (V)	Resistance tolerance (%)	Resistance range (Ω)	TCR*2 (x10-6/K)	Category temp. range (℃)		
ED ID 4 0*3	, ,	<b>5</b> ( )	1 (3)	50	± 0.5, ± 1	10 to 1 M (E24, E96)	± 100	3 ( - /		
ERJPA2*3	0402	0.25	100	50	± 5	10 to 1 M (E24)	± 200			
ERJPA3	ED IDAO 0000 0.00		0.22	450	± 0.5, ± 1	10 to 1 M (E24, E96)	± 100	FF 4- 14FF		
ERJPAS	0603	0.33	130	150	± 5	1 to 1.5 M (E24)	± 200	-55 to +155		
					± 0.5, ± 1	10 to 1 M (E24, E96)	R<33Ω : ± 300 33Ω≦R : ± 100			
ERJP06	0805	0.50	115	400	± 5	1 to 3.3 M (E24)	R<10Ω : -100 to +600 10Ω $\leq$ R<33Ω : ± 300 33Ω $\leq$ R : ± 200			

- \*1 :The rated power is guaranteed with the terminal part temperature prescript.
- \*2 :TCR is applied for the ± 1% product.
- \*3 :AEC-Q200 Grade1



# Small size & High power Wide terminal type

sizing

Anti solder **TCR** ioint crack

High

power

Surge AEC-

Anti-

**Q200** 

### **ERJB** series

#### Improvement of High power & Anti-Surge rating



# Number of pieces reduction

- 1. Down sizing
- 2. Weight saving
- 3. Cost saving

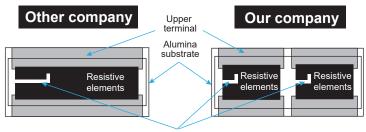
## High Anti-Surge performance

- 1. Failure reduction
- 2. Design margin securing





#### Higher power rating by wide termination structure with separated resistive elements



Trimming groove

- Separated resistive elements for surge distribution.
- · Achived small size & high power and overload characteristics.

#### Specifications

Part No.	Size (inch)	Power rating*1 (W)		Limiting element voltage (V)	Resistance tolerance (%)	Resistance range (Ω)	TCR*2 (x10-6/K)	Category temp. range (℃)			
ERJB1	1020	2.0 (R≦10)	125	200	± 1, ±2, ±5		10mΩ≤R<22mΩ : 0 to +350 22mΩ≤R<47mΩ : 0 to +200				
		1.0 (10 <r)< td=""><td>95</td><td></td><td><math>47m\Omega \le R &lt; 100m\Omega</math>: 0 to +150 <math>100m\Omega \le R \le 10k\Omega</math>: ± 100</td><td></td></r)<>	95				$47m\Omega \le R < 100m\Omega$ : 0 to +150 $100m\Omega \le R \le 10k\Omega$ : ± 100				
ERJB2	0612	1.5 (R≦1 K)	125	200	± 1, ±2, ±5		$\begin{array}{ll} 10m\Omega \leqq R < 22m\Omega & : 0 \text{ to } + 350 \\ 22m\Omega \leqq R < 47m\Omega & : 0 \text{ to } + 200 \end{array}$	-55 to +155			
		0.75 (1 K <r)< td=""><td>90</td><td></td><td><math>47m\Omega \le R &lt; 100m\Omega</math> : 0 to + 150 <math>100m\Omega \le R &lt; 220m\Omega</math>: 0 to + 100 <math>220m\Omega \le R \le 10M\Omega</math> : ± 100</td><td></td></r)<>	90				$47m\Omega \le R < 100m\Omega$ : 0 to + 150 $100m\Omega \le R < 220m\Omega$ : 0 to + 100 $220m\Omega \le R \le 10M\Omega$ : ± 100				
ERJB3	0508	1.0	105	150	± 1, ±2, ±5	(F24)	$22m\Omega \le R < 47m\Omega$ : 0 to + 300 $47m\Omega \le R < 1\Omega$ : 0 to + 200 $1\Omega \le R \le 10\Omega$ : ± 200				

- \*1 :The rated power is guaranteed with the terminal part temperature
- \*2 :TCR is applied for the ± 1% product.



# Down sizing proposal

Contributes to "PCB miniaturization" by replacing standard products with small & high-power products of the same or higher power rating.

Size (inch) Power (W)	0402	0603	0805	1206 0612 (Wide terminal)	3225	2010 1020 (Wide terminal)	2512
2.0						ERJB1	- 63% X 2p
1.0				ERJB2	- 6	5%	
0.75					45%		
0.5			ERJP06	<del>- 65</del> %			
0.25		ERJPA3	<b>–</b> 69%				
0.2	ERJPA2						
0.125		78%					

Our comapny

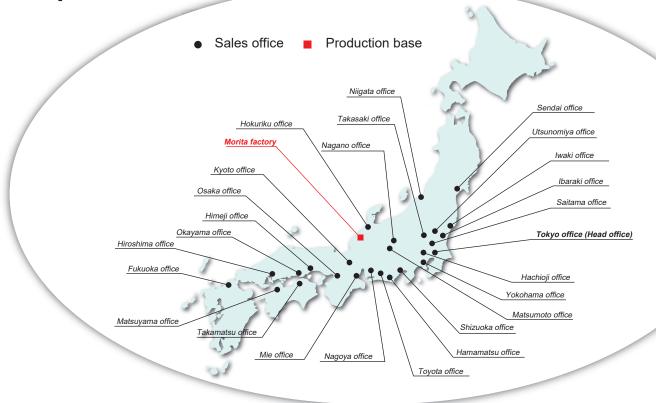
Standard

means down sizing rate (%) of PCB.

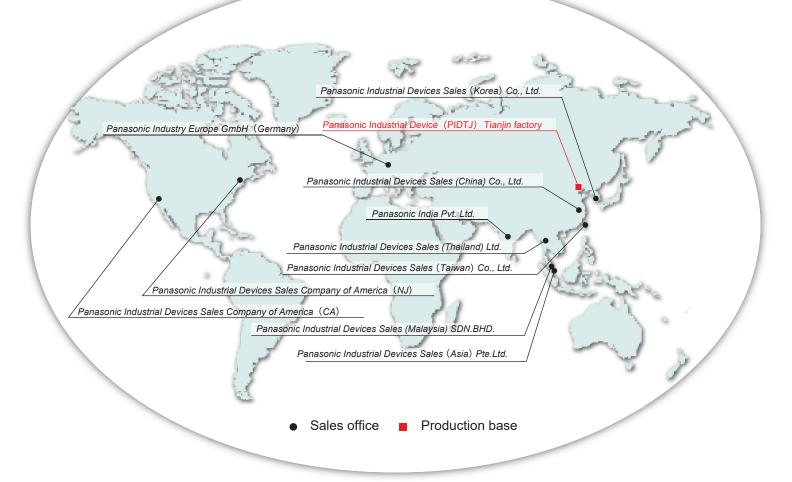
<sup>- 21 -</sup>

# **Main locations**

#### ■ Japan bases



#### Overseas bases



#### **Safty Precautions**

When using our products, no matter what sort of equipment they might be used for, be sure to confirm the applications and environmental conditions with our specifications in advance.

# Panasonic INDUSTRY

Thin / Thick film chip resistor

First edition : January 1, 2021
Revision : October 20, 2021
Revision : July 22, 2022
Revision : November 15, 2022
Revision : xxxxx, 2024

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